
HM5117800 Series

2,097,152-word \times 8-bit Dynamic Random Access Memory

HITACHI

ADE-203-632A (Z)

Rev. 1.0

Sep. 30, 1996

Description

The Hitachi HM5117800 is a CMOS dynamic RAM organized 2,097,152-word \times 8-bit. It employs the most advanced CMOS technology for high performance and low power. The HM5117800 offers Fast Page Mode as a high speed access mode. Multiplexed address input permits the HM5117800 to be packaged in standard 28-pin plastic SOJ and 28-pin TSOP.

Features

- Single 5 V ($\pm 10\%$)
- High speed
 - Access time: 60 ns/70 ns (max)
- Low power dissipation
 - Active mode: 660mW/605 mW (max)
 - Standby mode : 11 mW (max)
 : 0.83 mW (max) (L-version)
- Fast page mode capability
- Long refresh period
 - 2048 refresh cycles : 32 ms
 : 128 ms (L-version)
- 4 variations of refresh
 - $\overline{\text{RAS}}$ -only refresh
 - $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh
 - Hidden refresh
 - Self refresh (L-version)
- Battery backup operation (L-version)

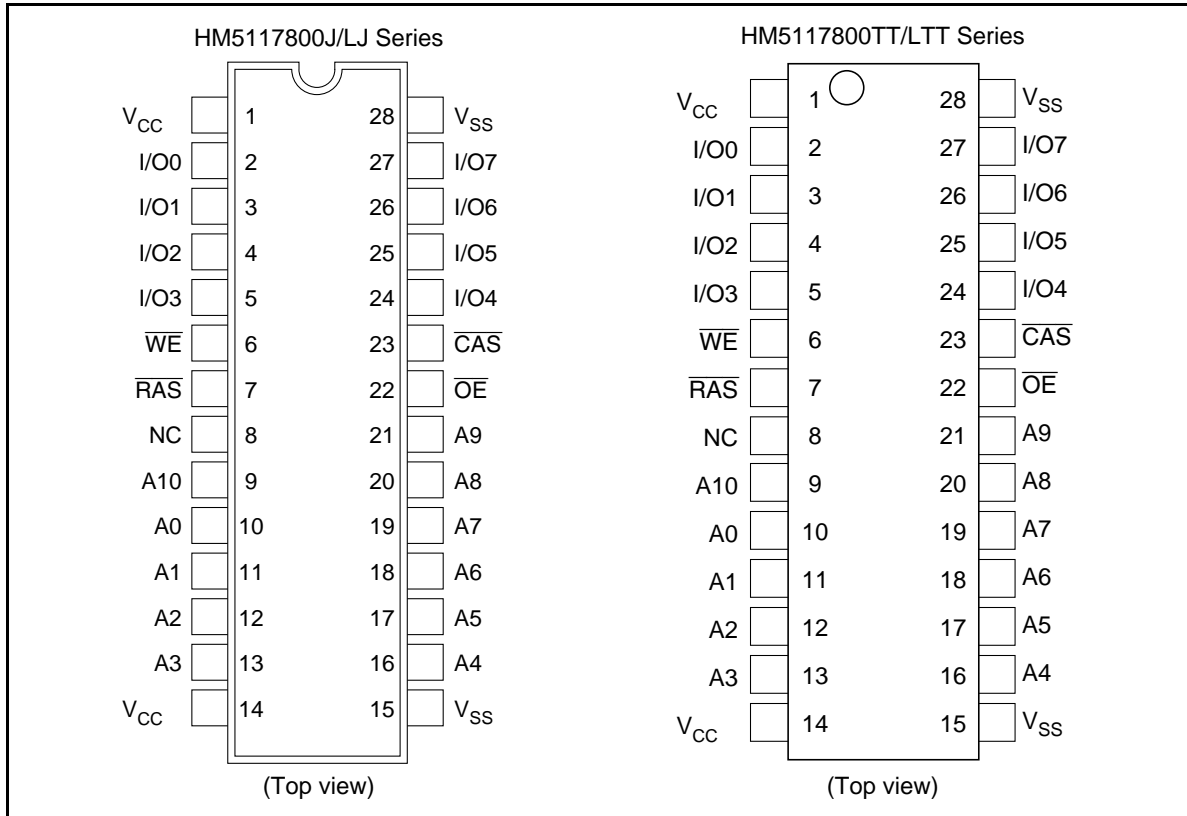
This specification is fully compatible with the 16-Mbit DRAM specifications from TEXAS INSTRUMENTS.

HM5117800 Series

Ordering Information

Type No.	Access time	Package
HM5117800J-6	60 ns	400-mil 28-pin plastic SOJ (CP-28DA)
HM5117800J-7	70 ns	
HM5117800LJ-6	60 ns	
HM5117800LJ-7	70 ns	
HM5117800TT-6	60 ns	400-mil 28-pin plastic TSOP II (TTP-28DA)
HM5117800TT-7	70 ns	
HM5117800LTT-6	60 ns	
HM5117800LTT-7	70 ns	

Pin Arrangement

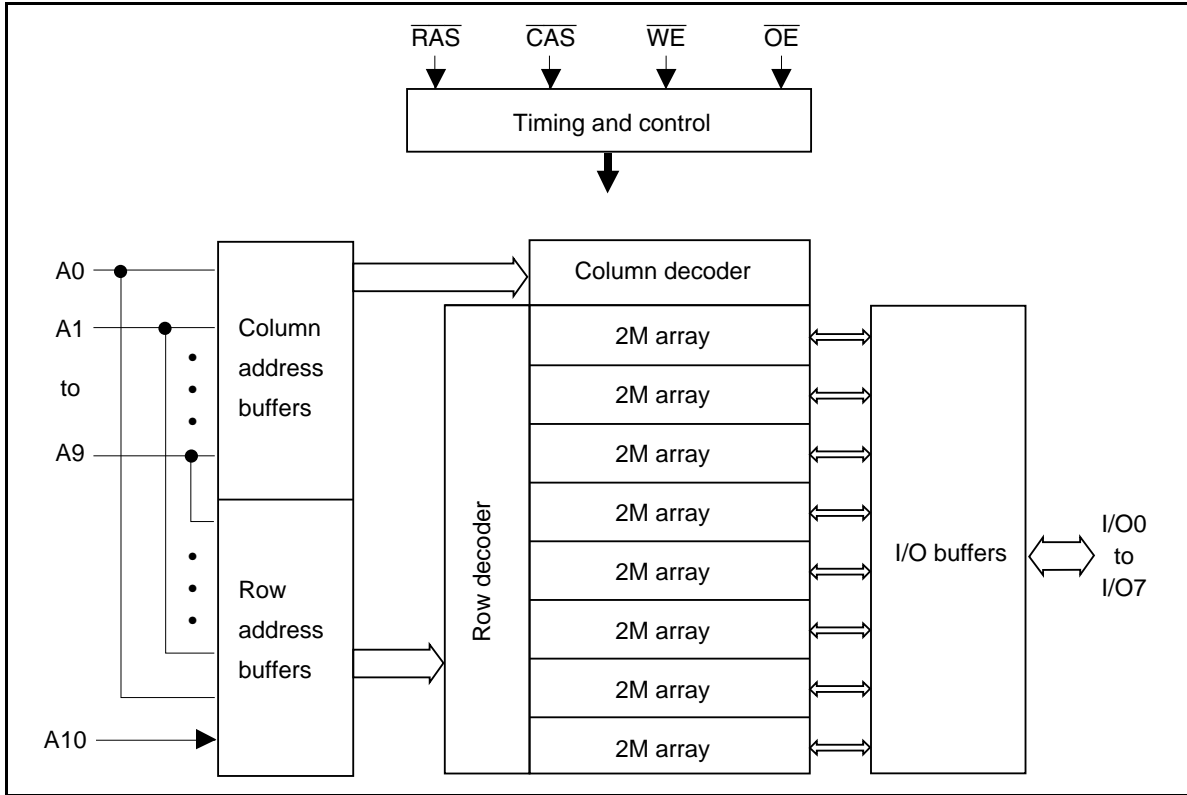


Pin Description

Pin name	Function
A0 to A10	Address input <ul style="list-style-type: none"> • Row/Refresh address A0 to A10 • Column address A0 to A9
I/O0 to I/O7	Data input/data output
\overline{RAS}	Row address strobe
\overline{CAS}	Column address strobe
\overline{WE}	Read/Write enable
\overline{OE}	Output enable
V _{CC}	Power supply
V _{SS}	Ground
NC	No connection

HM5117800 Series

Block Diagram



Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Voltage on any pin relative to V_{SS}	V_T	-1.0 to +7.0	V
Supply voltage relative to V_{SS}	V_{CC}	-1.0 to +7.0	V
Short circuit output current	I_{out}	50	mA
Power dissipation	P_T	1.0	W
Operating temperature	T_{opr}	0 to +70	°C
Storage temperature	T_{stg}	-55 to +125	°C

Recommended DC Operating Conditions ($T_a = 0$ to +70°C)

Parameter	Symbol	Min	Typ	Max	Unit	Note
Supply voltage	V_{CC}	4.5	5.0	5.5	V	1
Input high voltage	V_{IH}	2.4	—	6.5	V	1
Input low voltage	V_{IL}	-1.0	—	0.8	V	1

Note: 1. All voltage referred to V_{SS} .

HM5117800 Series

DC Characteristics (Ta = 0 to +70°C, V_{CC} = 5 V ±10%, V_{SS} = 0 V)

Parameter	Symbol	HM5117800				Unit	Test conditions
		-6		-7			
		Min	Max	Min	Max		
Operating current ^{*1, *2}	I _{CC1}	—	120	—	110	mA	t _{RC} = min
Standby current	I _{CC2}	—	2	—	2	mA	TTL interface R _{AS} , C _{AS} = V _{IH} Dout = High-Z
		—	1	—	1	mA	CMOS interface R _{AS} , C _{AS} ≥ V _{CC} - 0.2V Dout = High-Z
Standby current (L-version)	I _{CC2}	—	150	—	150	μA	CMOS interface R _{AS} , C _{AS} ≥ V _{CC} - 0.2V Dout = High-Z
R _{AS} -only refresh current ^{*2}	I _{CC3}	—	120	—	110	mA	t _{RC} = min
Standby current ^{*1}	I _{CC5}	—	5	—	5	mA	R _{AS} = V _{IH} C _{AS} = V _{IL} Dout = enable
C _{AS} -before-R _{AS} refresh current	I _{CC6}	—	120	—	110	mA	t _{RC} = min
Fast page mode current ^{*1, *3}	I _{CC7}	—	100	—	90	mA	t _{PC} = min
Battery backup current ^{*4} (Standby with CBR refresh) (L-version)	I _{CC10}	—	500	—	500	μA	CMOS interface Dout = High-Z CBR refresh: t _{RC} = 62.5 μs t _{RAS} ≤ 0.3 μs
Self refresh mode current (L-version)	I _{CC11}	—	300	—	300	μA	CMOS interface R _{AS} , C _{AS} ≤ 0.2V Dout = High-Z
Input leakage current	I _{LI}	-10	10	-10	10	μA	0 V ≤ Vin ≤ 7 V
Output leakage current	I _{LO}	-10	10	-10	10	μA	0 V ≤ Vout ≤ 7 V Dout = disable
Output high voltage	V _{OH}	2.4	V _{CC}	2.4	V _{CC}	V	High Iout = -5 mA
Output low voltage	V _{OL}	0	0.4	0	0.4	V	Low Iout = 4.2 mA

Notes: 1. I_{CC} depends on output load condition when the device is selected. I_{CC} max is specified at the output open condition.

2. Address can be changed once or less while R_{AS} = V_{IL}.

3. Address can be changed once or less while C_{AS} = V_{IH}.

4. C_{AS} = L (≤ 0.2 V) while R_{AS} = L (≤ 0.2 V).

HM5117800 Series

Capacitance (Ta = 25°C, V_{CC} = 5 V ± 10%)

Parameter	Symbol	Typ	Max	Unit	Notes
Input capacitance (Address)	C _{I1}	—	5	pF	1
Input capacitance (Clocks)	C _{I2}	—	7	pF	1
Output capacitance (Data-in, Data-out)	C _{I/O}	—	7	pF	1, 2

Notes: 1. Capacitance measured with Boonton Meter or effective capacitance measuring method.
2. $\overline{\text{CAS}} = V_{IH}$ to disable Dout.

AC Characteristics (Ta = 0 to +70°C, V_{CC} = 5 V ± 10%, V_{SS} = 0 V)^{*1, *2, *18}

Test Conditions

- Input rise and fall time: 5 ns
- Input timing reference levels: 0.8 V, 2.4 V
- Output load: 2 TTL gate + C_L (100 pF) (Including scope and jig)

HM5117800 Series

Read, Write, Read-Modify-Write and Refresh Cycles (Common parameters)

Parameter	Symbol	HM5117800				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
Random read or write cycle time	t_{RC}	110	—	130	—	ns	
\overline{RAS} precharge time	t_{RP}	40	—	50	—	ns	
\overline{CAS} precharge time	t_{CP}	10	—	10	—	ns	
\overline{RAS} pulse width	t_{RAS}	60	10000	70	10000	ns	
\overline{CAS} pulse width	t_{CAS}	15	10000	18	10000	ns	
Row address setup time	t_{ASR}	0	—	0	—	ns	
Row address hold time	t_{RAH}	10	—	10	—	ns	
Column address setup time	t_{ASC}	0	—	0	—	ns	
Column address hold time	t_{CAH}	10	—	15	—	ns	
\overline{RAS} to \overline{CAS} delay time	t_{RCD}	20	45	20	52	ns	3
\overline{RAS} to column address delay time	t_{RAD}	15	30	15	35	ns	4
\overline{RAS} hold time	t_{RSH}	15	—	18	—	ns	
\overline{CAS} hold time	t_{CSH}	60	—	70	—	ns	
\overline{CAS} to \overline{RAS} precharge time	t_{CRP}	5	—	5	—	ns	
\overline{OE} to Din delay time	t_{OED}	15	—	18	—	ns	5
\overline{OE} delay time from Din	t_{DZO}	0	—	0	—	ns	6
\overline{CAS} delay time from Din	t_{DZC}	0	—	0	—	ns	6
Transition time (rise and fall)	t_T	3	50	3	50	ns	7

HM5117800 Series

Read Cycle

Parameter	Symbol	HM5117800				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
Access time from $\overline{\text{RAS}}$	t_{RAC}	—	60	—	70	ns	8, 9
Access time from $\overline{\text{CAS}}$	t_{CAC}	—	15	—	18	ns	9,10,17
Access time from address	t_{AA}	—	30	—	35	ns	9,11,17
Access time from $\overline{\text{OE}}$	t_{OEA}	—	15	—	18	ns	9
Read command setup time	t_{RCS}	0	—	0	—	ns	
Read command hold time to $\overline{\text{CAS}}$	t_{RCH}	0	—	0	—	ns	12
Read command hold time to $\overline{\text{RAS}}$	t_{RRH}	0	—	0	—	ns	12
Column address to $\overline{\text{RAS}}$ lead time	t_{RAL}	30	—	35	—	ns	
Column address to $\overline{\text{CAS}}$ lead time	t_{CAL}	30	—	35	—	ns	
$\overline{\text{CAS}}$ to output in low-Z	t_{CLZ}	0	—	0	—	ns	
Output data hold time	t_{OH}	3	—	3	—	ns	
Output data hold time from $\overline{\text{OE}}$	t_{OHO}	3	—	3	—	ns	
Output buffer turn-off time	t_{OFF}	—	15	—	15	ns	13
Output buffer turn-off to $\overline{\text{OE}}$	t_{OEZ}	—	15	—	15	ns	13
$\overline{\text{CAS}}$ to Din delay time	t_{CDD}	15	—	18	—	ns	5

Write Cycle

Parameter	Symbol	HM5117800				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
Write command setup time	t_{WCS}	0	—	0	—	ns	14
Write command hold time	t_{WCH}	10	—	15	—	ns	
Write command pulse width	t_{WP}	10	—	10	—	ns	
Write command to $\overline{\text{RAS}}$ lead time	t_{RWL}	15	—	18	—	ns	
Write command to $\overline{\text{CAS}}$ lead time	t_{CWL}	15	—	18	—	ns	
Data-in setup time	t_{DS}	0	—	0	—	ns	15
Data-in hold time	t_{DH}	10	—	15	—	ns	15

HM5117800 Series

Read-Modify-Write Cycle

Parameter	Symbol	HM5117800				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
Read-modify-write cycle time	t_{RWC}	155	—	181	—	ns	
RAS to \overline{WE} delay time	t_{RWD}	85	—	98	—	ns	14
\overline{CAS} to \overline{WE} delay time	t_{CWD}	40	—	46	—	ns	14
Column address to \overline{WE} delay time	t_{AWD}	55	—	63	—	ns	14
\overline{OE} hold time from \overline{WE}	t_{OEh}	15	—	18	—	ns	

Refresh Cycle

Parameter	Symbol	HM5117800				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
\overline{CAS} setup time (CBR refresh cycle)	t_{CSR}	5	—	5	—	ns	
\overline{CAS} hold time (CBR refresh cycle)	t_{CHR}	10	—	10	—	ns	
\overline{WE} setup time (CBR refresh cycle)	t_{WRP}	0	—	0	—	ns	
\overline{WE} hold time (CBR refresh cycle)	t_{WRH}	10	—	10	—	ns	
RAS precharge to \overline{CAS} hold time	t_{RPC}	0	—	0	—	ns	

Fast Page Mode Cycle

Parameter	Symbol	HM5117800				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
Fast page mode cycle time	t_{PC}	40	—	45	—	ns	
Fast page mode \overline{RAS} pulse width	t_{RASP}	—	100000	—	100000	ns	16
Access time from \overline{CAS} precharge	t_{CPA}	—	35	—	40	ns	9, 17
\overline{RAS} hold time from \overline{CAS} precharge	t_{CPRH}	35	—	40	—	ns	

HM5117800 Series

Fast Page Mode Read-Modify-Write Cycle

Parameter	Symbol	HM5117800				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
Fast page mode read- modify-write cycle time	t_{PRWC}	85	—	96	—	ns	
\overline{WE} delay time from \overline{CAS} precharge	t_{CPW}	60	—	68	—	ns	14


Refresh

Parameter	Symbol	Max	Unit	Note
Refresh period	t_{REF}	32	ms	2048 cycles
Refresh period (L-version)	t_{REF}	128	ms	2048 cycles

Self Refresh Mode (L-version)

Parameter	Symbol	HM5117800L				Unit	Notes
		-6		-7			
		Min	Max	Min	Max		
\overline{RAS} pulse width (self refresh)	t_{RASS}	100	—	100	—	μ s	
\overline{RAS} precharge time (self refresh)	t_{RPS}	110	—	130	—	ns	
\overline{CAS} hold time (self refresh)	t_{CHS}	-50	—	-50	—	ns	

HM5117800 Series

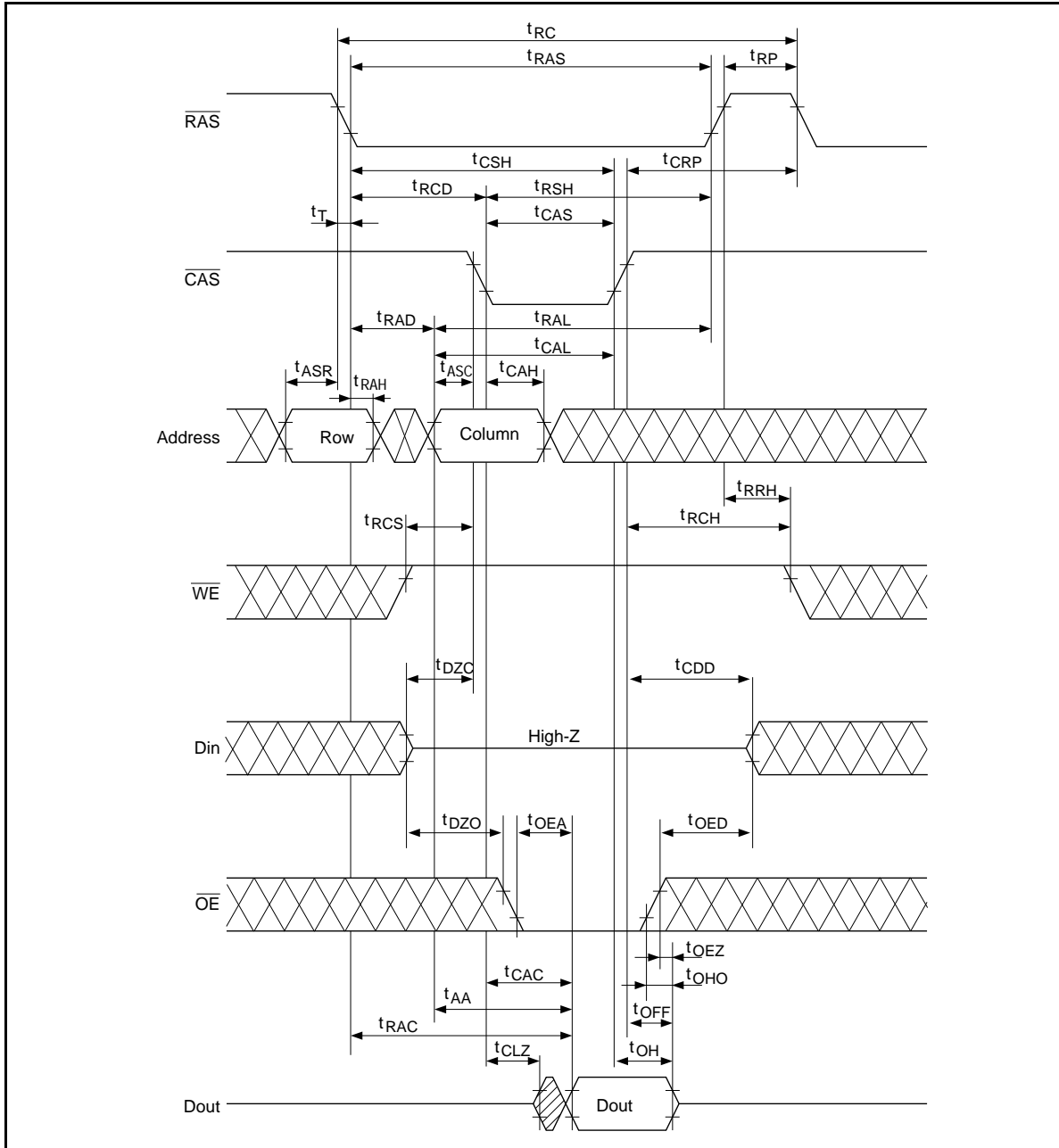
- Notes:
- AC measurements assume $t_r = 5$ ns.
 - An initial pause of 200 μ s is required after power up followed by a minimum of eight initialization cycles (any combination of cycles containing $\overline{\text{RAS}}$ -only refresh or $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh). If the internal refresh counter is used, a minimum of eight $\overline{\text{CAS}}$ -before- $\overline{\text{RAS}}$ refresh cycles are required.
 - Operation with the t_{RCD} (max) limit insures that t_{RAC} (max) can be met, t_{RCD} (max) is specified as a reference point only; if t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC} .
 - Operation with the t_{RAD} (max) limit insures that t_{RAC} (max) can be met, t_{RAD} (max) is specified as a reference point only; if t_{RAD} is greater than the specified t_{RAD} (max) limit, then access time is controlled exclusively by t_{AA} .
 - Either t_{OED} or t_{CDD} must be satisfied.
 - Either t_{DZO} or t_{DZC} must be satisfied.
 - V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IH} (min) and V_{IL} (max).
 - Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \leq t_{\text{RAD}}$ (max). If t_{RCD} or t_{RAD} is greater than the maximum recommended value shown in this table, t_{RAC} exceeds the value shown.
 - Measured with a load circuit equivalent to 2 TTL loads and 100 pF.
 - Assumes that $t_{\text{RCD}} \geq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \leq t_{\text{RAD}}$ (max).
 - Assumes that $t_{\text{RCD}} \leq t_{\text{RCD}}$ (max) and $t_{\text{RAD}} \geq t_{\text{RAD}}$ (max).
 - Either t_{RCH} or t_{RRH} must be satisfied for a read cycles.
 - t_{OFF} (max) and t_{OEZ} (max) define the time at which the outputs achieve the open circuit condition and are not referred to output voltage levels.
 - t_{WCS} , t_{RWD} , t_{CWD} , t_{AWD} and t_{CPW} are not restrictive operating parameters. They are included in the data sheet as electrical characteristics only; if $t_{\text{WCS}} \geq t_{\text{WCS}}$ (min), the cycle is an early write cycle and the data out pin will remain open circuit (high impedance) throughout the entire cycle; if $t_{\text{RWD}} \geq t_{\text{RWD}}$ (min), $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), and $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min), or $t_{\text{CWD}} \geq t_{\text{CWD}}$ (min), $t_{\text{AWD}} \geq t_{\text{AWD}}$ (min) and $t_{\text{CPW}} \geq t_{\text{CPW}}$ (min), the cycle is a read-modify-write and the data output will contain data read from the selected cell; if neither of the above sets of conditions is satisfied, the condition of the data out (at access time) is indeterminate.
 - These parameters are referred to $\overline{\text{CAS}}$ leading edge in early write cycles and to $\overline{\text{WE}}$ leading edge in delayed write or read-modify-write cycles.
 - t_{RASP} defines $\overline{\text{RAS}}$ pulse width in Fast page mode cycles.
 - Access time is determined by the longest among t_{AA} , t_{CAC} and t_{CPA} .
 - In delayed write or read-modify-write cycles, $\overline{\text{OE}}$ must disable output buffer prior to applying data to the device.
 - Please do not use t_{RASS} timing, $10 \mu\text{s} \leq t_{\text{RASS}} \leq 100 \mu\text{s}$. During this period, the device is in transition state from normal operation mode to self refresh mode. If $t_{\text{RASS}} \geq 100 \mu\text{s}$, then $\overline{\text{RAS}}$ precharge time should use t_{RPS} instead of t_{RP} .
 - If you use $\overline{\text{RAS}}$ only refresh or CBR burst refresh mode in normal read/write cycles, 2048 cycles of distributed CBR refresh with 15.6 μs interval should be executed within 32 ms immediately after exiting from and before entering into the self refresh mode.
 - If you use distributed CBR refresh mode with 15.6 μs interval in normal read/write cycle, CBR refresh should be executed within 15.6 μs immediately after exiting from and before entering into self refresh mode.
 - Repetitive self refresh mode without refreshing all memory is not allowed. Once you exit from self refresh mode, all memory cells need to be refreshed before re-entering the self refresh mode again.
 -  H or L (H: V_{IH} (min) $\leq V_{\text{IN}} \leq V_{\text{IH}}$ (max), L: V_{IL} (min) $\leq V_{\text{IN}} \leq V_{\text{IL}}$ (max))

 Invalid Dout

When the address, clock and input pins are not described on timing waveforms, their pins must be applied V_{IH} or V_{IL} .

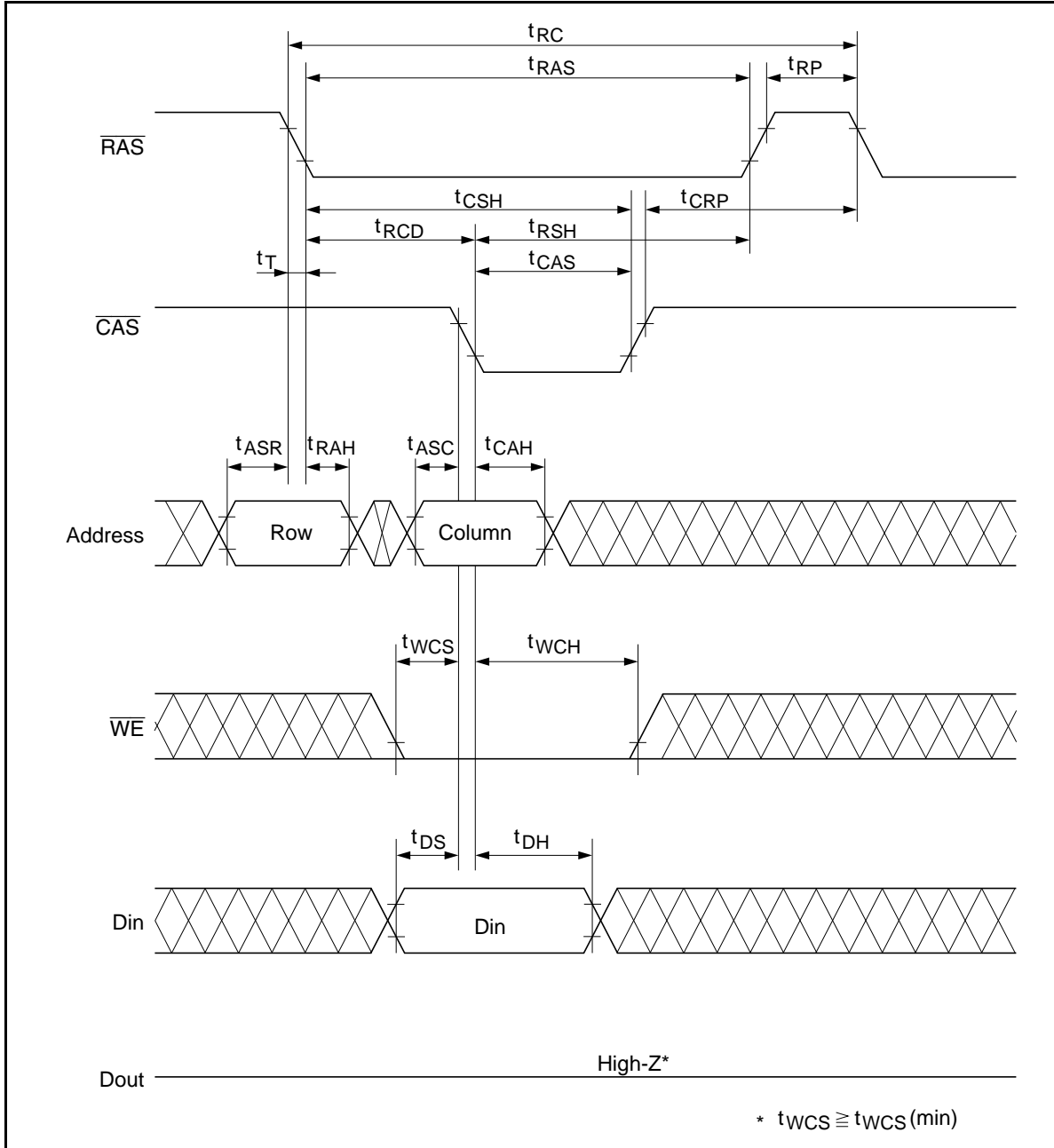
Timing Waveforms ^{*23}

Read Cycle

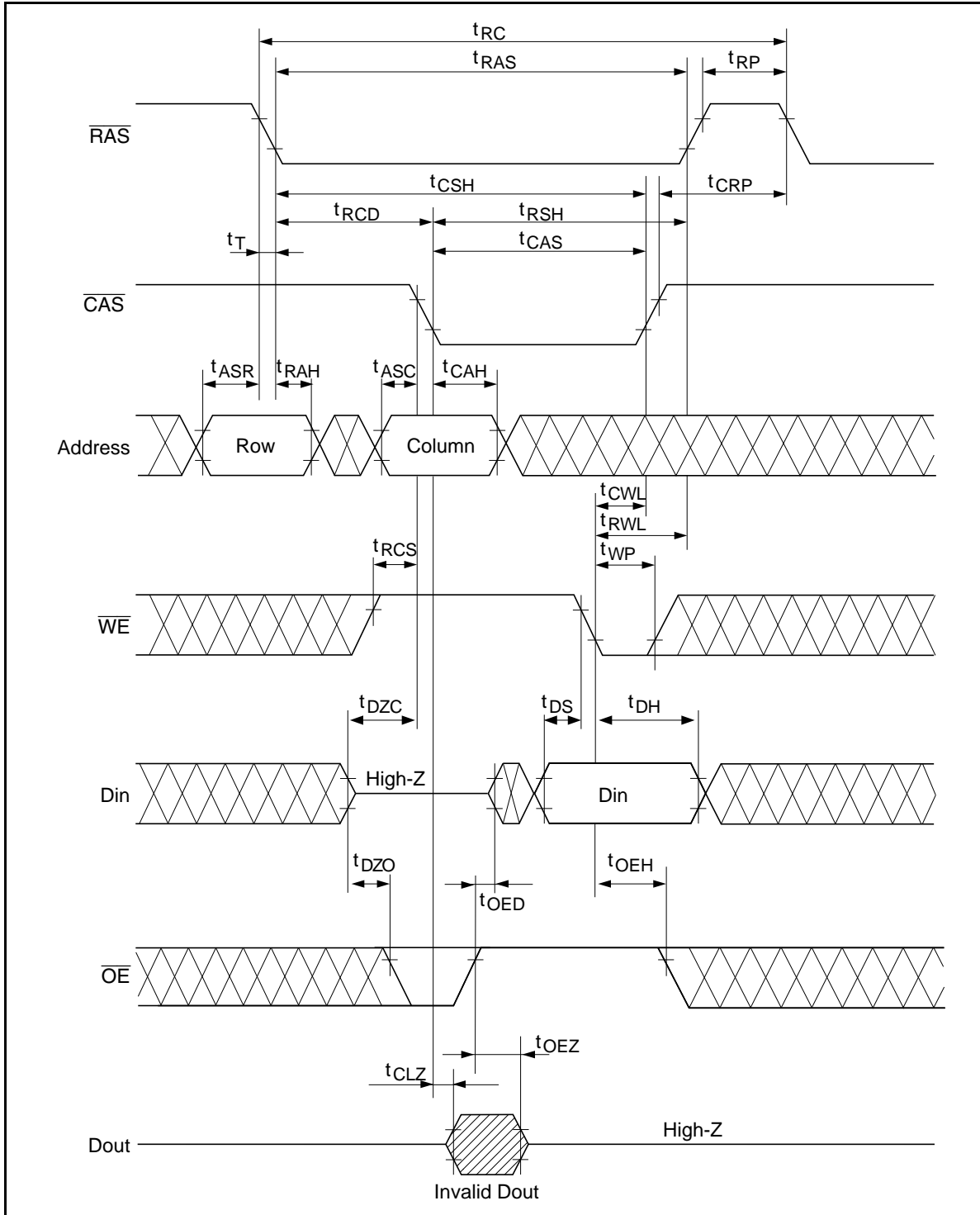


HM5117800 Series

Early Write Cycle

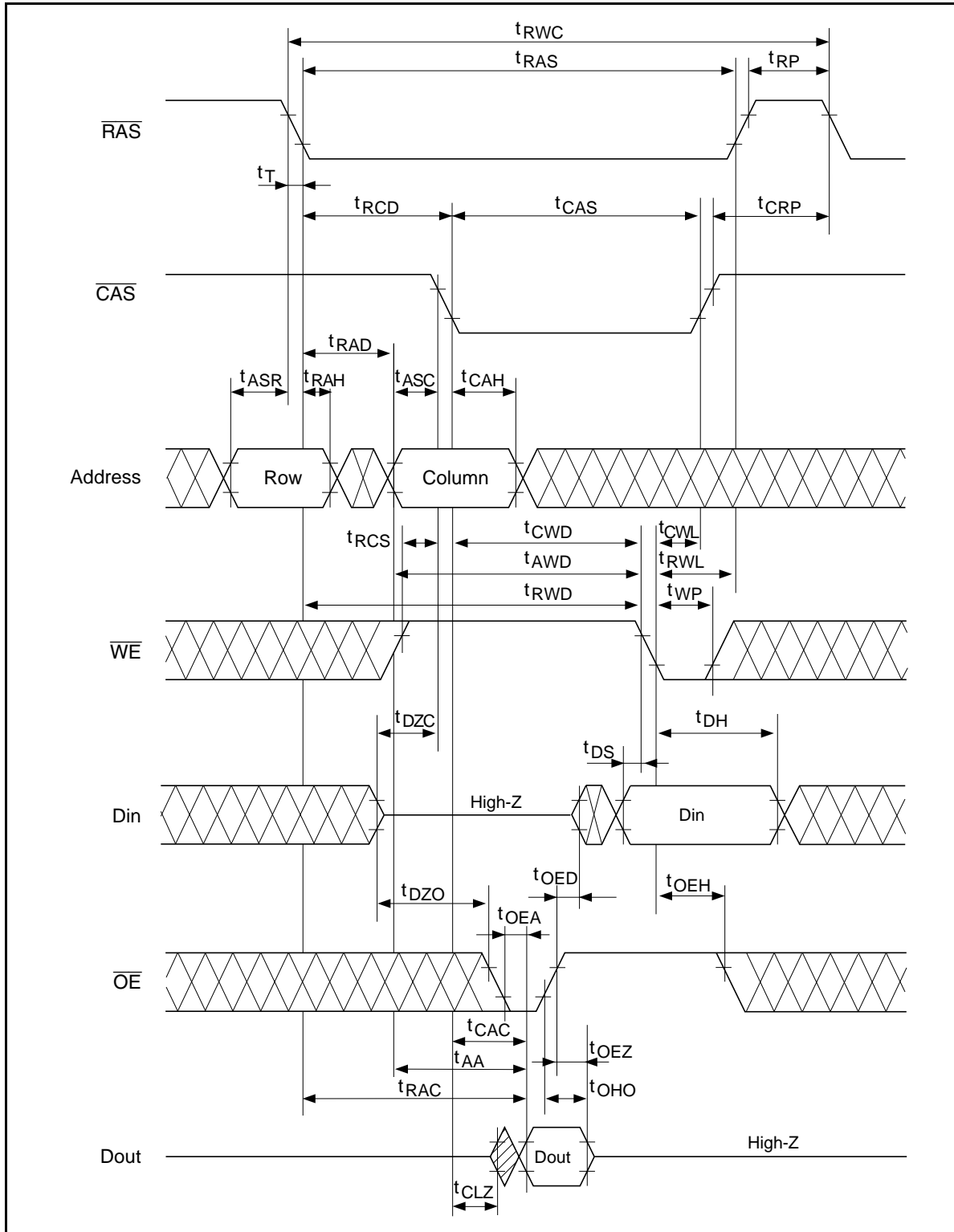


Delayed Write Cycle^{*18}

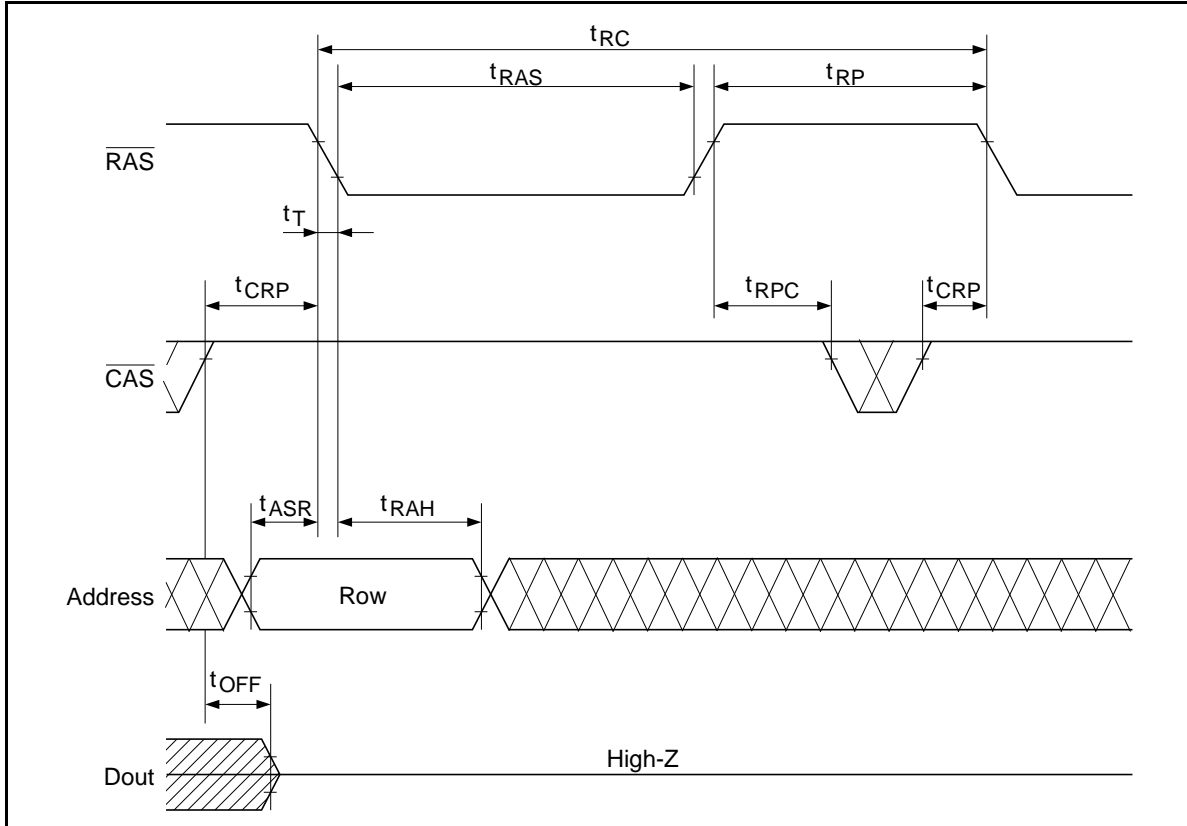


HM5117800 Series

Read-Modify-Write Cycle^{*18}

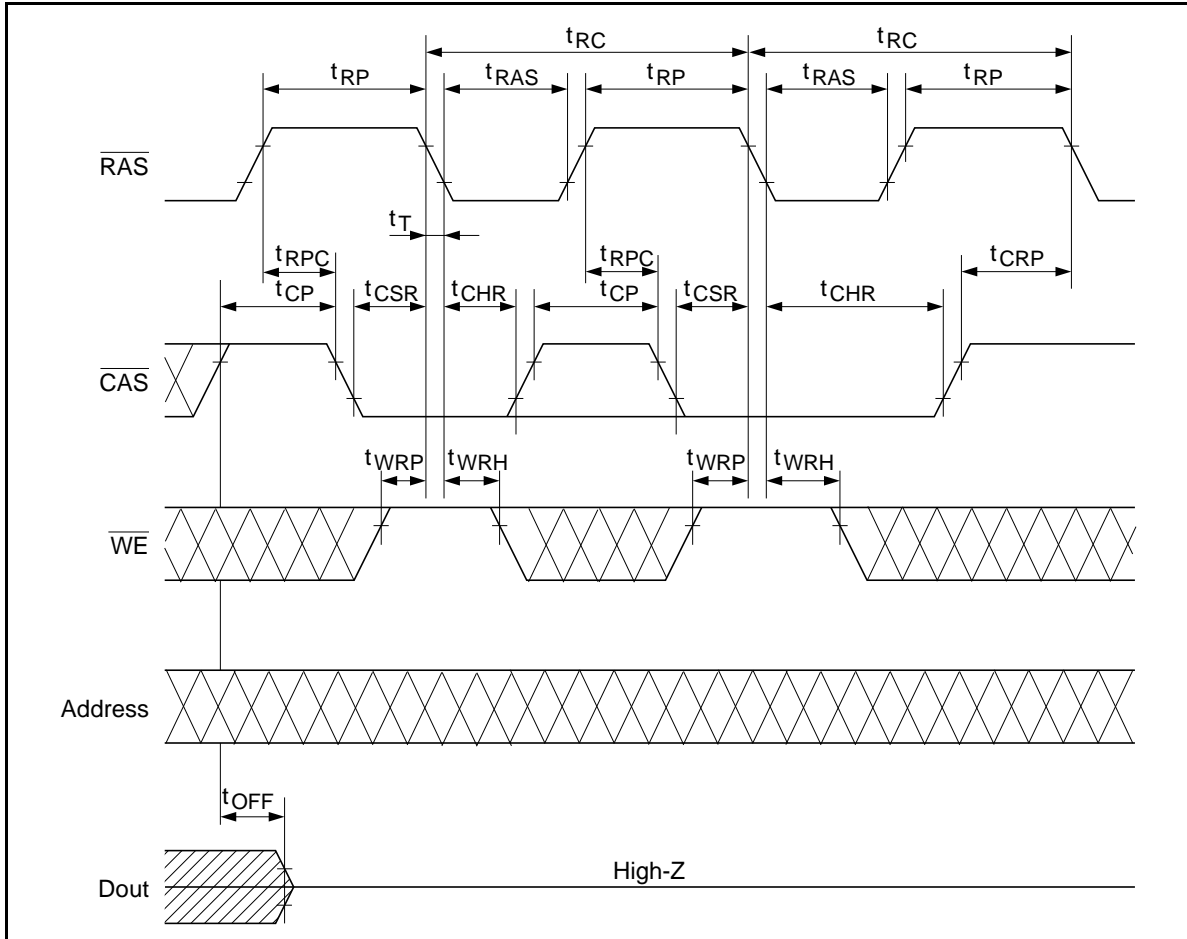


$\overline{\text{RAS}}$ -Only Refresh Cycle

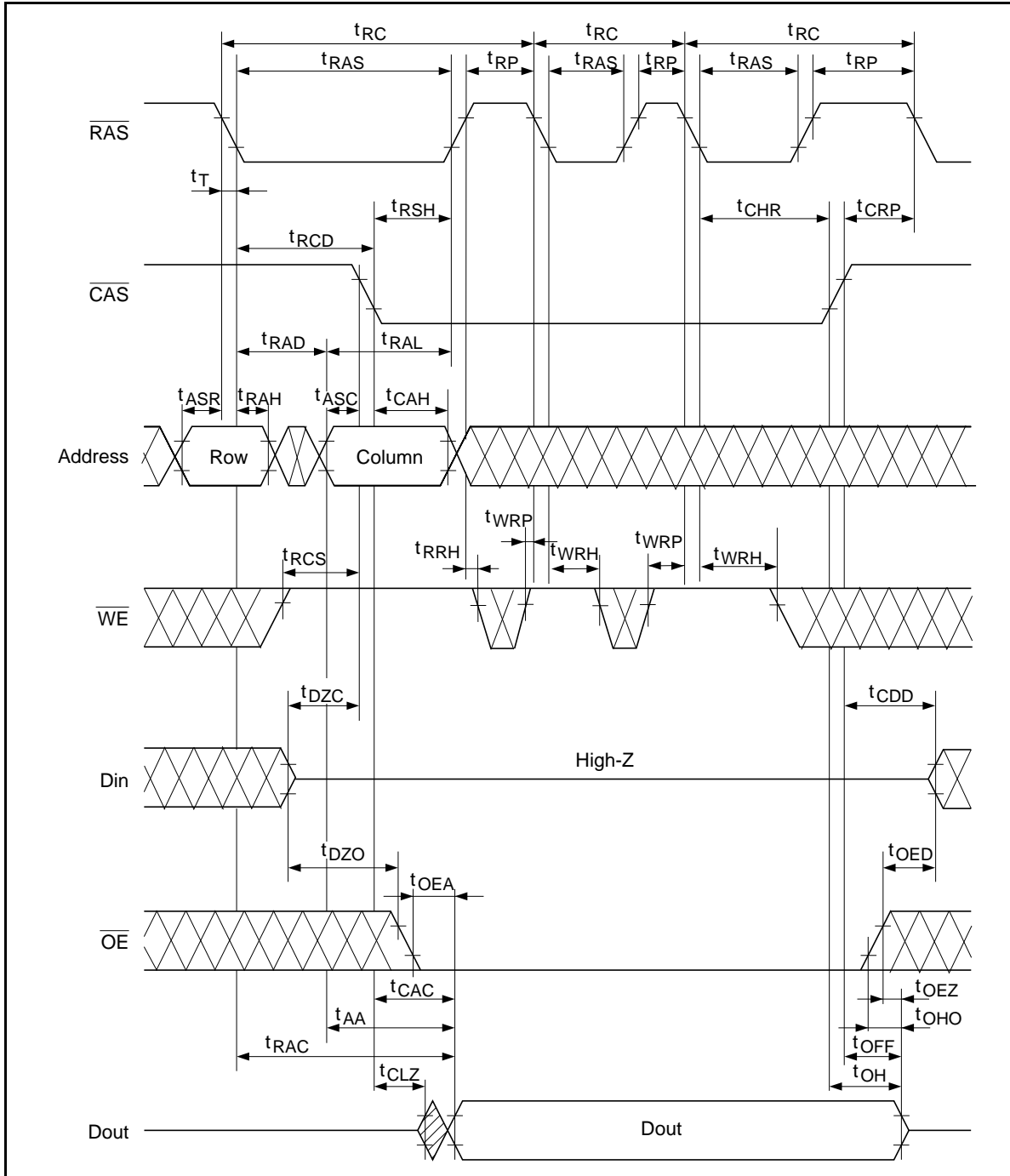


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$\overline{\text{CAS}}$ -Before- $\overline{\text{RAS}}$ Refresh Cycle

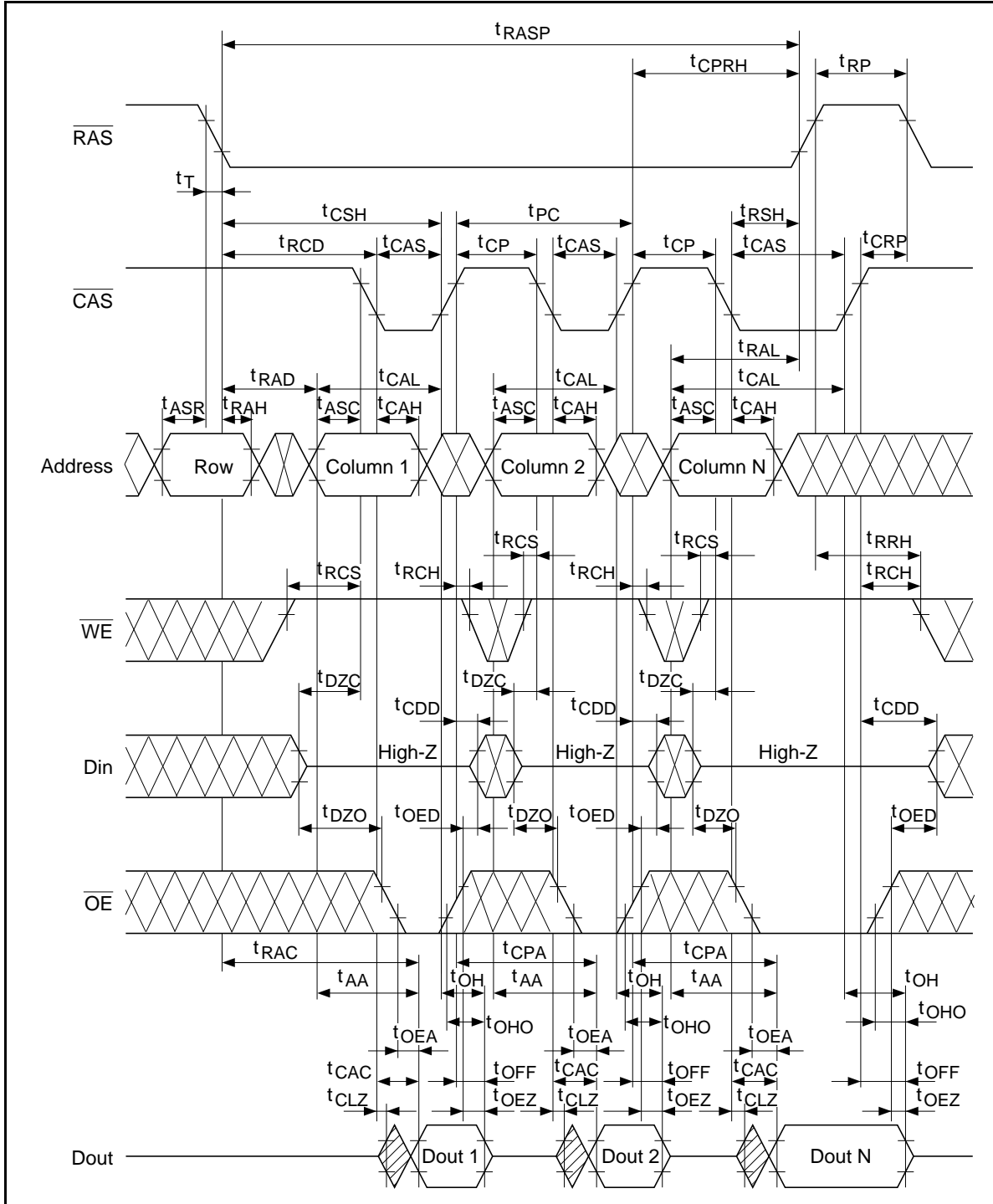


Hidden Refresh Cycle

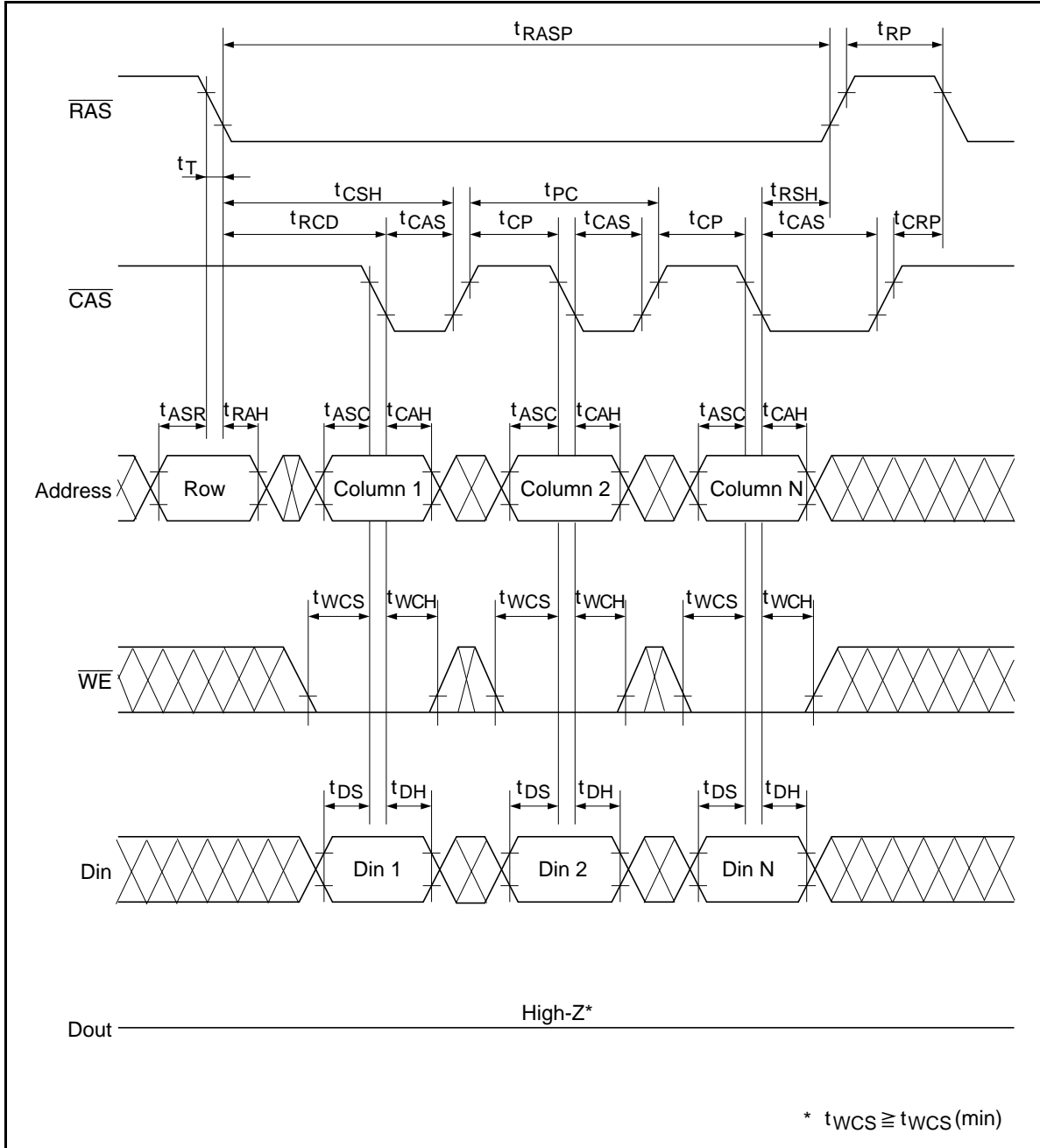


HM5117800 Series

Fast Page Mode Read Cycle

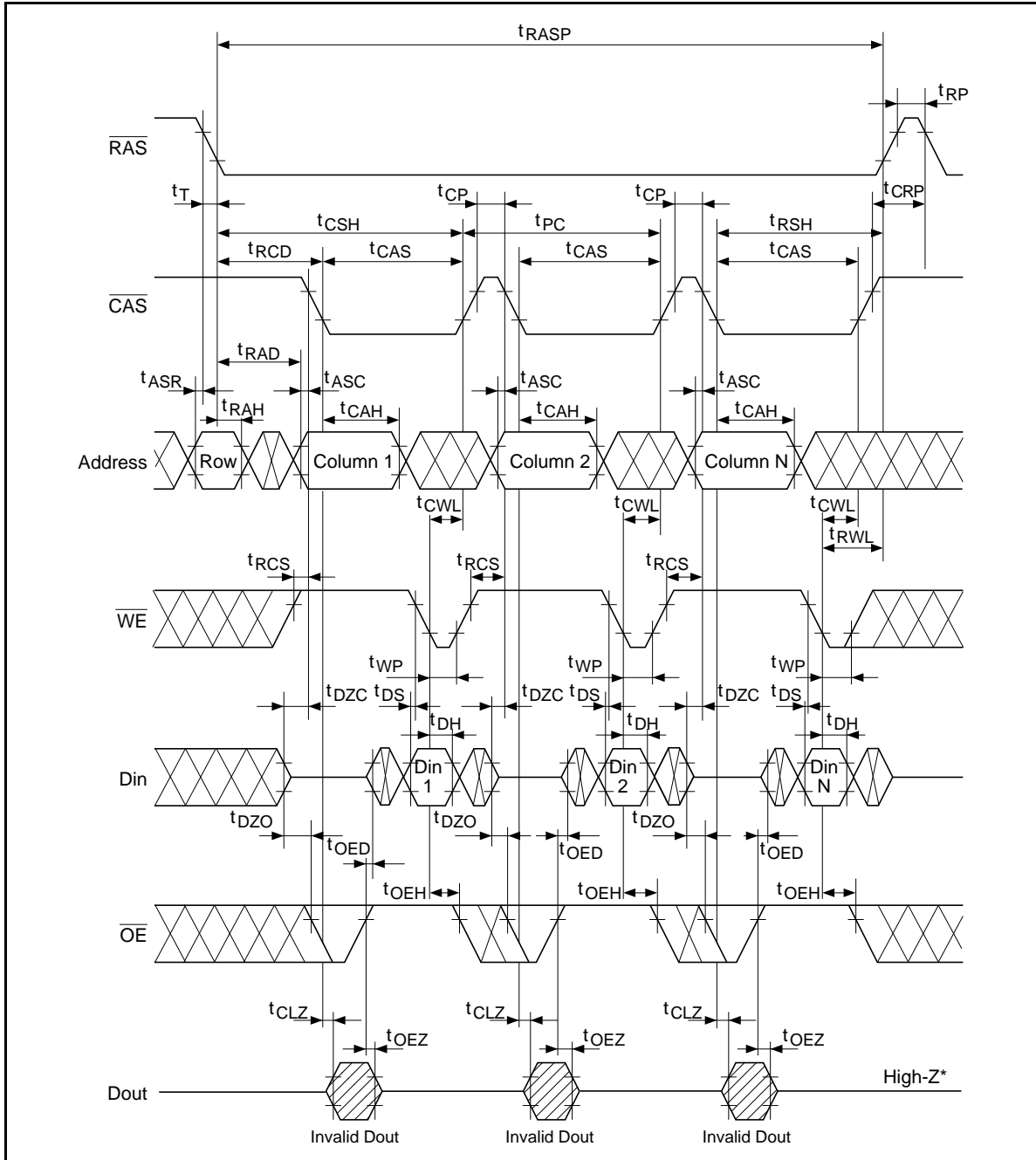


Fast Page Mode Early Write Cycle

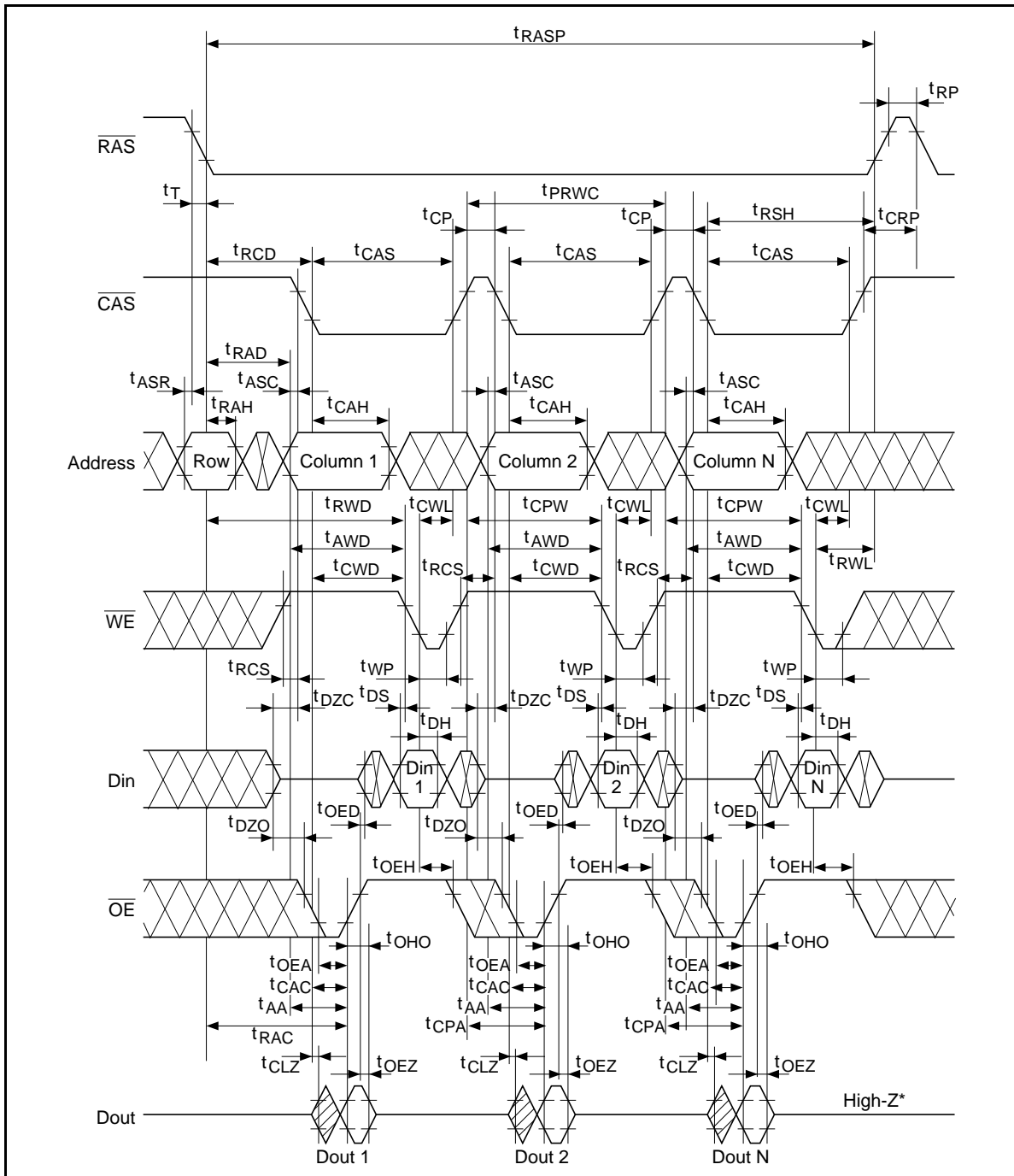


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Fast Page Mode Delayed Write Cycle^{*18}

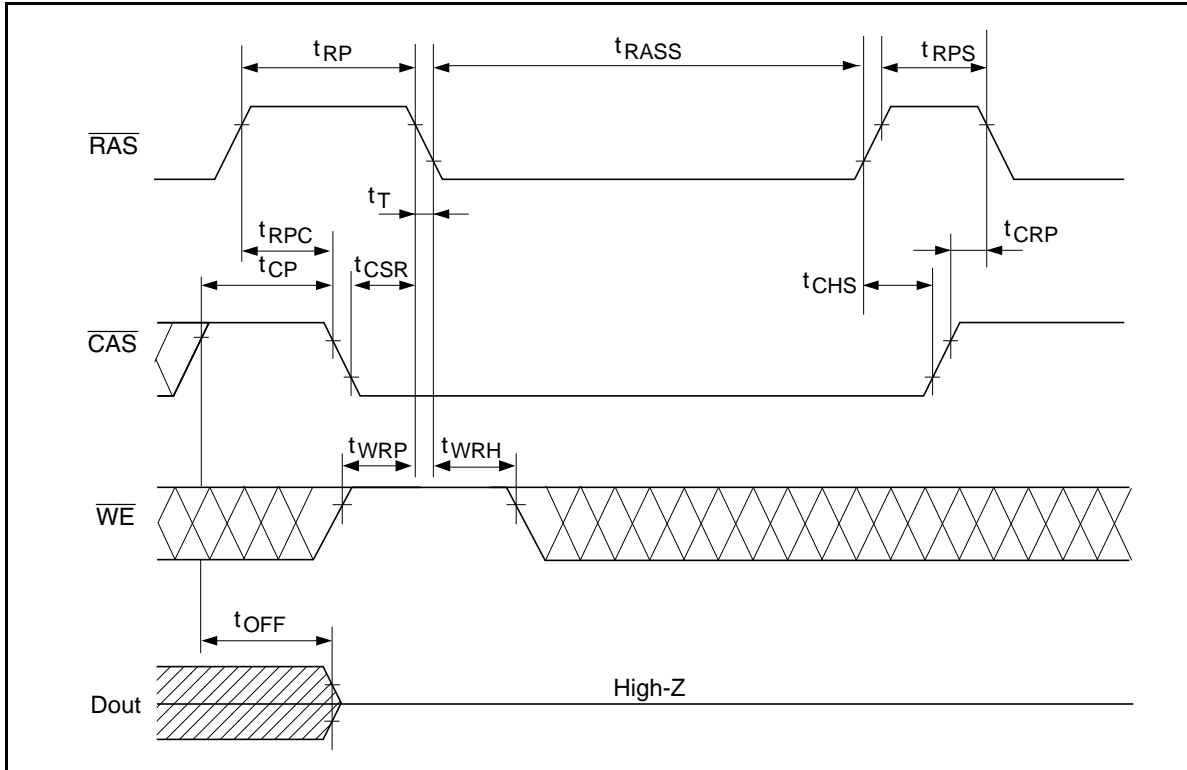


Fast Page Mode Read-Modify-Write Cycle*18



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Self Refresh Cycle (L-version)*19, 20, 21, 22

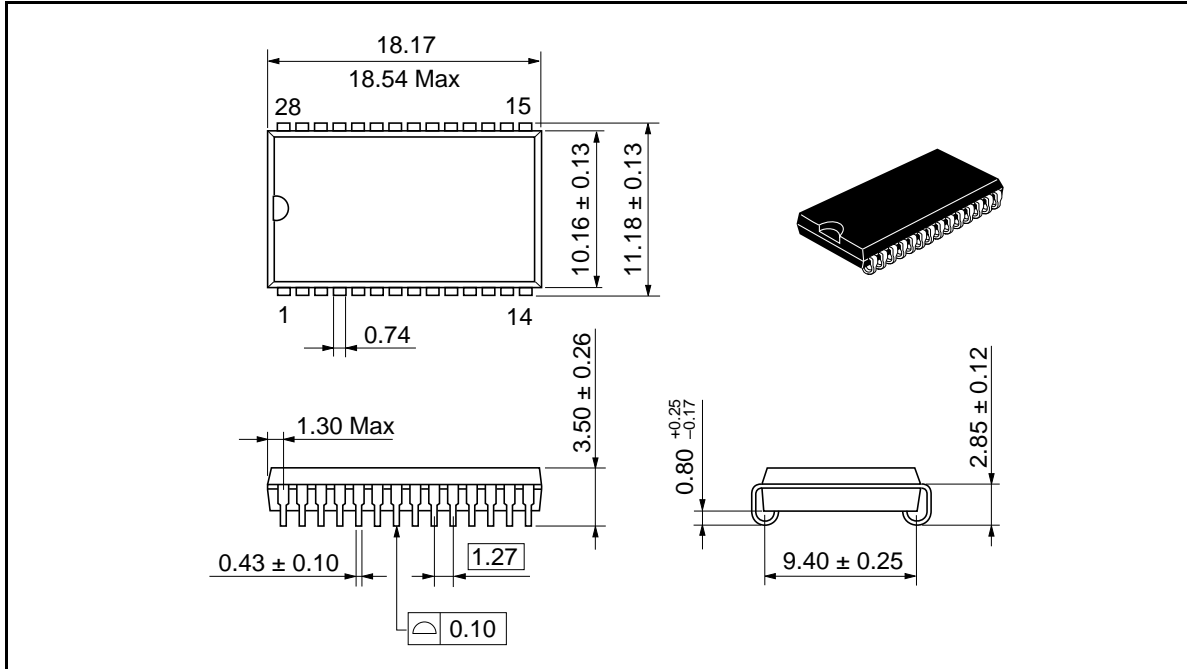


HM5117800 Series

Package Dimensions

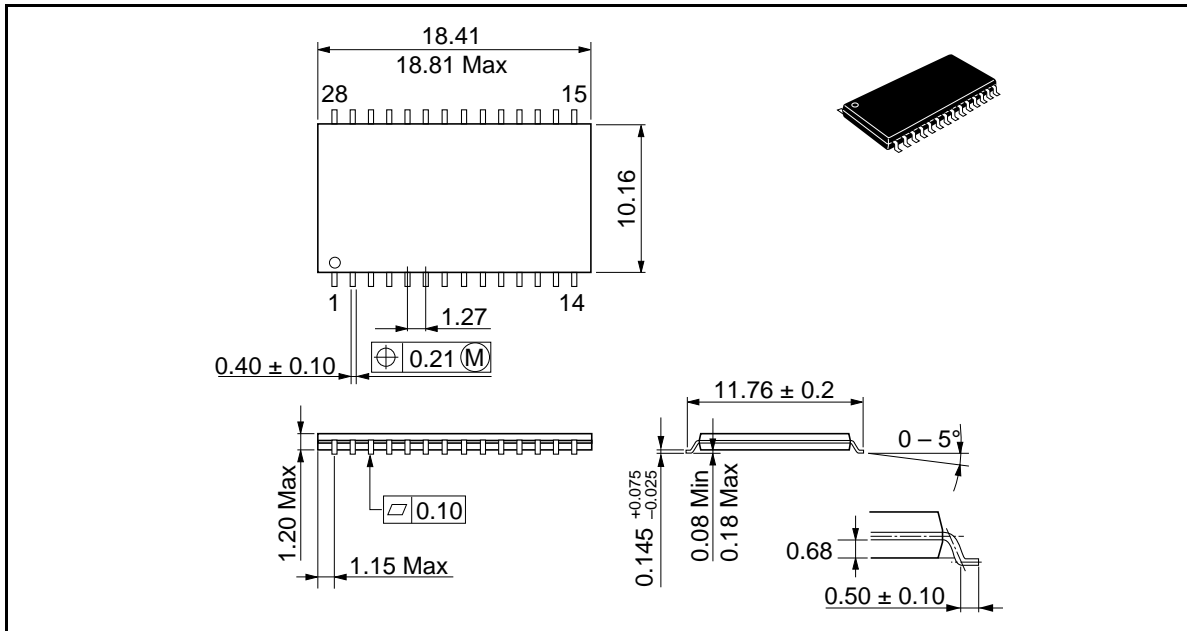
HM5117800J/LJ Series (CP-28DA)

Unit: mm



HM5117800TT/LTT Series (TTP-28DA)

Unit: mm



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Revision Record

Rev.	Date	Contents of Modification	Drawn by	Approved by
1.0	Sep. 30, 1996	Initial issue		
